



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE2060K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

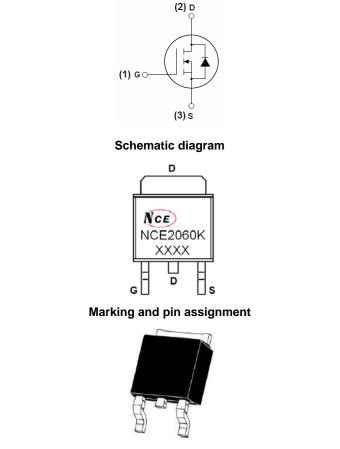
- V_{DS} =20V,I_D =60A
- $R_{DS(ON)}$ <6m Ω @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE2060K	NCE2060K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	20	V
Gate-Source Voltage	Vgs	±12	V
Drain Current-Continuous	Ι _D	60	А
Drain Current-Continuous(T _C =100 ℃)	l _D (100℃)	42	A
Pulsed Drain Current	I _{DM}	210	A
Maximum Power Dissipation	PD	60	W
Derating factor		0.48	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	200	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C





NCE2060K

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	2.1	°C /W	
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·	·	•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	0.5	0.75	1.0	V
		V _{GS} =4.5V, I _D =20 A	-	4.8	6	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =2.5V, I _D =15A		6.2	9	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =20A	15	-	-	S
Dynamic Characteristics (Note4)	·	·	•			
Input Capacitance	C _{lss}		-	2000	-	PF
Output Capacitance	Coss	V _{DS} =10V,V _{GS} =0V, F=1.0MHz	-	500	-	PF
Reverse Transfer Capacitance	C _{rss}		-	200	-	PF
Switching Characteristics (Note 4)	·	·	•			
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS
Turn-on Rise Time	tr	V_{DD} =10V,I _D =2A,R _L =1Ω	-	17.2	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =4.5V,R _G =3Ω	-	29.6	-	nS
Turn-Off Fall Time	t _f		-	16.8	-	nS
Total Gate Charge	Qg	V 40V/L 00A	-	27		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=10V, I_{D}=20A,$	-	6.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.4		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	25	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	24	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE				y LS+LD)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. E_{AS} condition : Tj=25 $^\circ \! \mathbb{C}$, V_{DD} =10V, V_G =10V, L=0.5mH, Rg=25\Omega ,

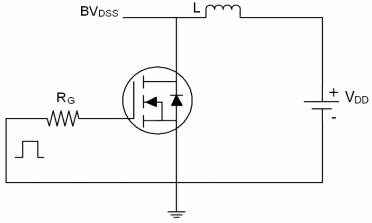
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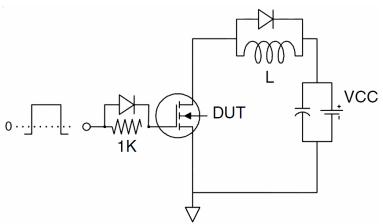
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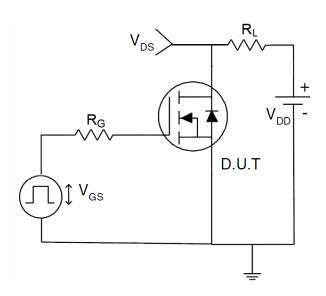
Test circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit







25

12

0.4

0.6

0.8

18

24

T_J = 25 °C

1.0

30

50

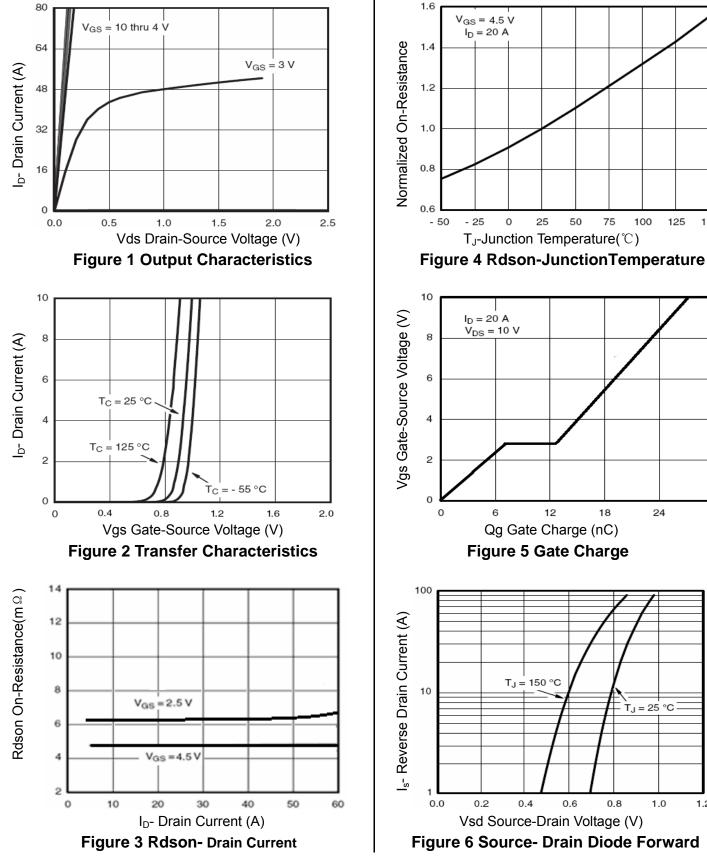
75

100

125

150

Typical Electrical and Thermal Characteristics (Curves)



1.2



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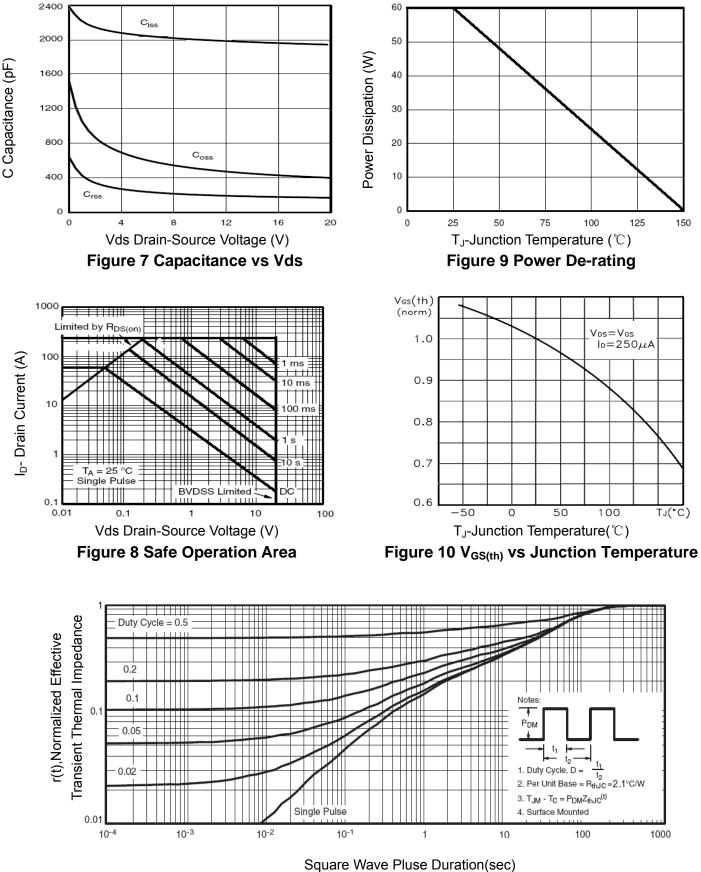


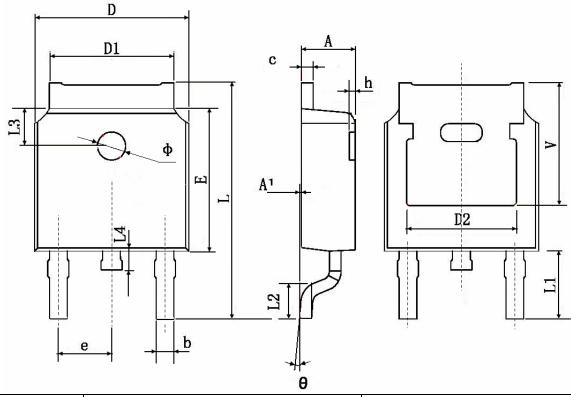
Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-252 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	4.830 TYP.		TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063	TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		





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